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AMENDMENT TRANSMITTAL LETTER Docket No. 51380(70329)							
Application No.		Filing (1	Examiner		Art Unit	
10/078,766-Conf. #4845		February 1	19, 2002	W. T. Leader	r	1742	
Applicant(s): Miur	pplicant(s): Miura Takashi et al.						
nvention: PROCESS FOR ELECTROPLATING SILICON WAFERS							
TO THE COMMISSIONER FOR PATENTS Transmitted herewith is an amendment in the above-identified application.							
The fee has been				• •			
		CLAIM	IS AS AMENI	DED			
	Claims Remaining After Amendment	Highest Number Previously Paid	Number Extra Claims Present	Rate			
Total Claims		- 20 =	!	X	I		
Independent Claims		- 3 =		x			
Multiple Depend	ent Claims (che	eck if applicable	e)		: 		
Other fee (please	e specify): E	Extension for res	ponse within th	nird month	4	1,020.00	
TOTAL ADDITI	ONAL FEE FO	OR THIS AME	NDMENT:			1,020.00	
x Large Entity Small Entity							
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X Please charg A duplicate c	ge Deposit Acc copy of this she			n the amount of \$ _	1,020	.00	
A check in th	ne amount of \$		to cover	the filing fee is enclo	osed.		
Payment by	credit card. Fo	orm PTO-2038	is attached.				
The Director is hereby authorized to charge and credit Deposit Account No04-1105 as described below. A duplicate copy of this sheet is enclosed.							
x Credit any overpayment.							
Charge any additional filing or application processing fees required under 37 CFR 1.16 and 1.17.							
Dated: September 26, 2005							
Peter F. Corless Attorney Reg. No.: 33,860							
EDWARDS & ANGELL, LLP P.O. Box 55874 Boston, Massachusetts 02205 (617) 439-4444							
I hereby certify that this in an envelope address	correspondence is	being deposited w	vith the U.S. Posta	al Service as Express Mail, D. Box 1450, Algxandria, VA	, Airbill No. E	V437824678US,	
shown below.		1	00			50, 5.1. 2.12	

Dated: September 26, 2005

Signature:

(Peter F. Corless)

PTO/SB/17 (12-04v2)

Approved for use through 7/31/2006. OMB 0651-0032

U.S. Patent and Trademark Office; U.S. DEPARTMENT OF COMMERCE

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Effective on 12/08/2004,			Complete if Known						
Fees pursuant to the Consolidated Appropriations Act, 2005 (H.R. 4818).			Application Number 10/078,766-Conf.			onf. #4845			
FEE TRANSMITTAL				Filing Date February 19		2002			
For FY 2005				First Named Inventor Miura Takashi					
	FULFI	201	J 5		Examiner Name W. T. Leader				
Applican	t claims small entity	/ status	i. See 37 CFR 1.2	7	Art Unit 1742				
TOTAL AMOU	NT OF PAYMEN	ΙT	(\$) 1,020.0	10	Attorney Docke	t No.	51380(70329)	
METHOD OF	PAYMENT (cl	eck a	II that apply)						
Check Credit Card Money Order None Other (please identify):									
X Deposit Ac	x Deposit Account Number: 04-1105 Deposit Account Name: Edwards & Angell, LLP								
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FEE CALCU	G, SEARCH, AN	D EV	AMINATION EE						
I. DASIC FILIN	G, SEARCH, AN		ING FEES		ARCH FEES	FXAM	INATION FEE	S	
	_		Small Entity		Small Entity		Small Entity		
Application T		e (\$)	Fee (\$)	Fee (\$		Fee (\$		Fees F	Paid (\$)
Utility		300	150	500	250	200	100		
Design		200	100	100	50	130	65		
Plant		200	100	300	150	160	80		
Reissue		300	150	500	250	600	300		
Provisional	:	200	100	0	0	0	0		
2. EXCESS CL	AIM FEES								Small Entity
Fee Description								<u>Fee (\$)</u>	<u>Fee (\$)</u>
Each claim ove	r 20 (including F	teissu	es)					50	25
Each independe	ent claim over 3	includ	ling Reissues)					200	100
Multiple depend	dent claims							360	180
Total Claims	Extra Clair	ns	Fee (\$)	Fee	Paid (\$)	ا	Multiple Depen	dent Claims	•
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Indep. Claims	Extra Clain	ns	Fee (\$)	Fee I	Paid (\$)				
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3. APPLICATIO									
If the specification and drawings exceed 100 sheets of paper (excluding electronically filed sequence or computer listings under 37 CFR 1.52(e)), the application size fee due is \$250 (\$125 for small entity) for each additional 50 sheets or fraction thereof. See 35 U.S.C. 41(a)(1)(G) and 37 CFR 1.16(s).									
Total Sheets Extra Sheets Number of each additional 50 or fraction thereof Fee (\$) Fee Paid (\$)									
- 100 = /50 (round up to a whole number) x =									
4. OTHER FEE(S) Fees Paid (\$)									
Non-English Specification, \$130 fee (no small entity discount)									
Other (e.g., late filing surcharge): 1253 Extension for response within third month 1,020.00									
SUBMITTED BY	1								
Signature		7,			Registration No. (Attorney/Agent)	33,860) Telephone	(617) 43	9-4444
Name (Print/Type)	Peter F. Corle	ess			<u></u>		Date	September	26, 2005

in an envelope addressed to: MS	dence is being deposited with the U.S. P. Amendment, Commissioner for Patents,	ostal Service as Express Mail, Airbill No. EV437824678US, P.O. Box 1450 Alexandria, VA 22313-1450, on the date
shown below.	.///	
Dated: September 26, 2005	Signature:	(Peter F. Corless)

Express Mail Label No. EV437824678US Docket No. 51380

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANT:

Takashi et al.

SERIAL NO.

10/078,766

GROUP:

1742

FILED:

February 19, 2002

EXAMINER: W. Leader

FOR:

PROCESS FOR ELECTROPLATING SILICON WAFERS

Mail Stop: Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

AMENDMENT

Applicants are in receipt of the Office Action dated March 25, 2005. Please amend the above-identified application as follows.

A listing of pending claims begins on page 2 of this paper.

Remarks begin on page 4 of this paper.